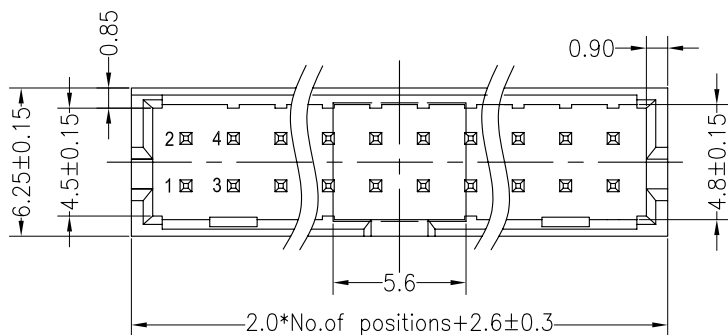
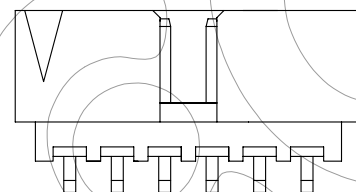
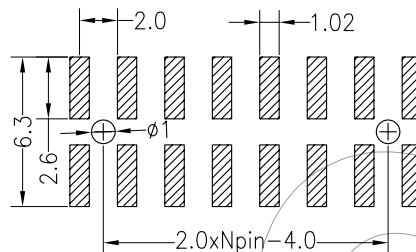


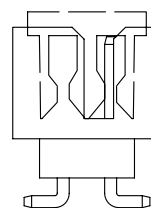
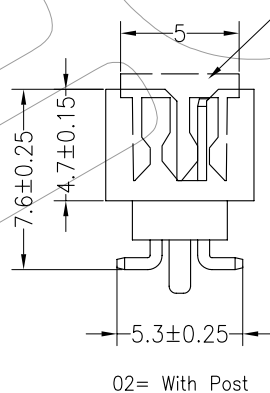
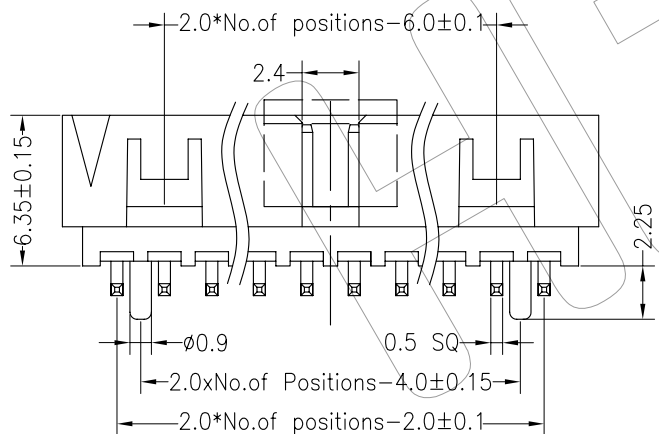
RoHS



Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)



TYPE FOR 6~12Pin



SPECIFICATIONS

Rated Current:1.5AMP
Contact Resistance:20mΩ Max
Withstand Voltage:400V AC/DC
Insulation Resistance:800MΩ Min
Operation Temperature:-40°C to +105°C

Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V-0)
Standard: PA6T
Max.Processing Temp: 230°C for 30-60 seconds
(260°C for 10 seconds)

Ordering Information

HC-BH521XX M XX XB K00 X 01(2)

No.of
Pins
6--64

Contact Plating
G0:Gold Flash
G2:5U" Gold
G3:10U" Gold
G4:15U" Gold
G5:30U" Gold
S0:Gold Flash/Tin
SN:Tin

Insulator Material
Option
A=BK-PBT
B=BK-PA66
C=BK-PA6T
D=BK-PA46
F=BK-LCP

Packing
0=PE Bag
A=Tray
T=Tube
P=Tube+Cap
R=Reel+Cap

				OPERATION		DRAW	Ayang		SCALE	FIT	HECON 东莞市禾康电子有限公司 DONGGUAN HECON ELECTRONICS CO.,LTD	
				X.X	±0.30				UNIT	mm		
				X.XX	±0.20	CHECK			SIZE	A4	PART NO.	HC-BH521XXMXXB K00X01(2)
				X.XXX	±0.10				SHEET	1/1		
A0		NEW DRAWING		Angle	±3°	APPROVE			SHEET	1/1	TITLE:	2.0mm H6.35 SMT Npin Box Header
REV	DATE	MODIFICATION DESCRIPTION	CHANGE	DIM	TOL				PROJ.			